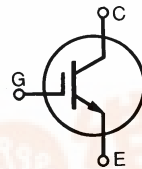




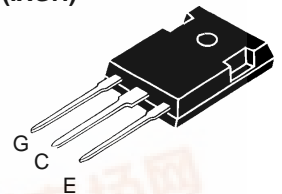
HiPerFAST™ IGBT IXGH 28N30B IXGT 28N30B

$V_{CES} = 300\text{ V}$
 $I_{C25} = 56\text{ A}$
 $V_{CE(sat)typ} = 2.1\text{ V}$
 $t_{fi(typ)} = 55\text{ ns}$

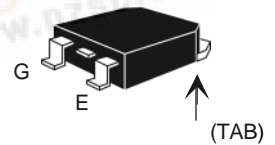


| Symbol | Test Conditions | Maximum Ratings | |
|---|--|---|------------------|
| V_{CES} | $T_J = 25^\circ\text{C}$ to 150°C | 300 | V |
| V_{CGR} | $T_J = 25^\circ\text{C}$ to 150°C ; $R_{GE} = 1\text{ M}\Omega$ | 300 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ\text{C}$ | 56 | A |
| I_{C90} | $T_C = 90^\circ\text{C}$ | 28 | A |
| I_{CM} | $T_C = 25^\circ\text{C}$, 1 ms | 112 | A |
| SSOA (RBSOA) | $V_{GE} = 15\text{ V}$, $T_{VJ} = 125^\circ\text{C}$, $R_G = 10\ \Omega$ Clamped inductive load, $L = 100\ \mu\text{H}$ | $I_{CM} = 56$ @ 0.8 V_{CES} | A |
| P_C | $T_C = 25^\circ\text{C}$ | 150 | W |
| T_J | | -55 ... +150 | $^\circ\text{C}$ |
| T_{JM} | | 150 | $^\circ\text{C}$ |
| T_{stg} | | -55 ... +150 | $^\circ\text{C}$ |
| Maximum Lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s | | 300 | $^\circ\text{C}$ |
| Maximum Tab temperature for soldering SMD devices for 10 s | | 260 | $^\circ\text{C}$ |
| M_d | Mounting torque (M3) | 1.13/10 | Nm/lb.in. |
| Weight | | TO-247 AD | 6 g |
| | | TO-268 | 4 g |

TO-247 AD (IXGH)



TO-268 (IXGT)



G = Gate, C = Collector,
 E = Emitter, TAB = Collector

Features

- International standard packages JEDEC TO-268 surface and JEDEC TO-247 AD
- High current handling capability
- Newest generation HDMOS™ process
- MOS Gate turn-on - drive simplicity

Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switched-mode and resonant-mode power supplies

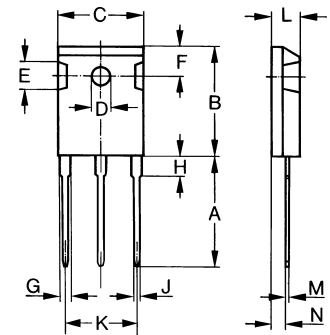
Advantages

- High power density
- Suitable for surface mounting
- Switching speed for high frequency applications
- Easy to mount with 1 screw, (isolated mounting screw hole)

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|---------------|---|---|-----------|---------------------|
| | | min. | typ. | max. |
| BV_{CES} | $I_C = 250\ \mu\text{A}$, $V_{GE} = 0\text{ V}$ | 300 | | V |
| $V_{GE(th)}$ | $I_C = 250\ \mu\text{A}$, $V_{CE} = V_{GE}$ | 2.5 | | V |
| I_{CES} | $V_{CE} = 0.8 \cdot V_{CES}$, $V_{GE} = 0\text{ V}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ | | 200 1 | μA mA |
| I_{GES} | $V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$ | | ± 100 | nA |
| $V_{CE(sat)}$ | $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$ | 2.1 | 2.4 | V |

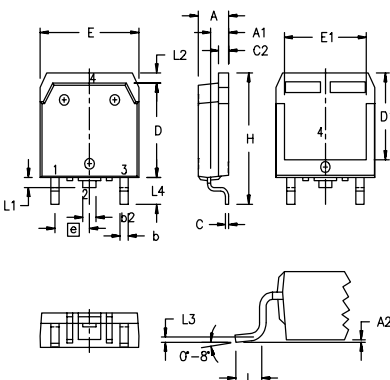
| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|--------------|---|---|--------|----------|
| | | min. | typ. | max. |
| g_{fs} | $I_C = I_{C90}$; $V_{CE} = 10\text{ V}$, Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$ | 12 | 18 | S |
| C_{ies} | $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 1\text{ MHz}$ | | 1500 | pF |
| C_{oes} | | | 130 | pF |
| C_{res} | | | 40 | pF |
| Q_g | $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $V_{CE} = 0.5 V_{CES}$ | | 90 | nC |
| Q_{ge} | | | 15 | nC |
| Q_{gc} | | | 35 | nC |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $L = 100\ \mu\text{H}$, $V_{CE} = 0.8 V_{CES}$, $R_G = R_{off} = 4.7\ \Omega$ Remarks: Switching times may increase for V_{CE} (Clamp) $> 0.8 \cdot V_{CES}$, higher T_J or increased R_G | | 15 | ns |
| t_{ri} | | | 30 | ns |
| $t_{d(off)}$ | | | 50 | ns |
| t_{fi} | | | 55 | ns |
| E_{off} | | | 0.3 | mJ |
| $t_{d(on)}$ | Inductive load, $T_J = 125^\circ\text{C}$ $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $L = 100\ \mu\text{H}$, $V_{CE} = 0.8 V_{CES}$, $R_G = R_{off} = 4.7\ \Omega$ Remarks: Switching times may increase for V_{CE} (Clamp) $> 0.8 \cdot V_{CES}$, higher T_J or increased R_G | | 15 | ns |
| t_{ri} | | | 30 | ns |
| E_{on} | | | 0.3 | mJ |
| $t_{d(off)}$ | | | 90 | 180 ns |
| t_{fi} | | | 110 | 230 ns |
| E_{off} | | 0.6 | 1.4 mJ | |
| R_{thJC} | | | | 0.83 K/W |
| R_{thCK} | | 0.25 | | K/W |

TO-247 AD (IXGH) Outline



| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 19.81 | 20.32 | 0.780 | 0.800 |
| B | 20.80 | 21.46 | 0.819 | 0.845 |
| C | 15.75 | 16.26 | 0.610 | 0.640 |
| D | 3.55 | 3.65 | 0.140 | 0.144 |
| E | 4.32 | 5.49 | 0.170 | 0.216 |
| F | 5.4 | 6.2 | 0.212 | 0.244 |
| G | 1.65 | 2.13 | 0.065 | 0.084 |
| H | - | 4.5 | - | 0.177 |
| J | 1.0 | 1.4 | 0.040 | 0.055 |
| K | 10.8 | 11.0 | 0.426 | 0.433 |
| L | 4.7 | 5.3 | 0.185 | 0.209 |
| M | 0.4 | 0.8 | 0.016 | 0.031 |
| N | 1.5 | 2.49 | 0.087 | 0.102 |

TO-268AA (D³ PAK)



| Dim. | Millimeter | | Inches | |
|----------------|------------|-------|----------|------|
| | Min. | Max. | Min. | Max. |
| A | 4.9 | 5.1 | .193 | .201 |
| A ₁ | 2.7 | 2.9 | .106 | .114 |
| A ₂ | .02 | .25 | .001 | .010 |
| b | 1.15 | 1.45 | .045 | .057 |
| b ₂ | 1.9 | 2.1 | .75 | .83 |
| C | .4 | .65 | .016 | .026 |
| D | 13.80 | 14.00 | .543 | .551 |
| E | 15.85 | 16.05 | .624 | .632 |
| E ₁ | 13.3 | 13.6 | .524 | .535 |
| e | 5.45 BSC | | .215 BSC | |
| H | 18.70 | 19.10 | .736 | .752 |
| L | 2.40 | 2.70 | .094 | .106 |
| L ₁ | 1.20 | 1.40 | .047 | .055 |
| L ₂ | 1.00 | 1.15 | .039 | .045 |
| L ₃ | 0.25 BSC | | .010 BSC | |
| L ₄ | 3.80 | 4.10 | .150 | .161 |

Min. Recommended Footprint

